

PS7241-1C

# 8-PIN SOP 400 V BREAK DOWN VOLTAGE TRANSFER TYPE 2-ch Optical Coupled MOS FET

### **DESCRIPTION**

The PS7241-1C is a transfer type solid state relay containing normally open (N.O.) contact and normally close (N.C.) contact on output side.

It is suitable for analog signal control because of their low offset and high linearity.

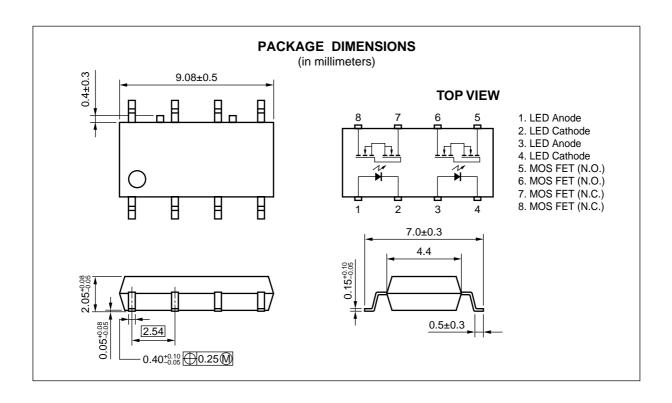
#### **FEATURES**

- 2 channel type (1 a + 1 b output)
- Low LED operating current (IF = 2 mA)
- · Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- · Low offset voltage
- · Ordering number of taping product: PS7241-1C-F3, F4
- UL approved: File No. E72422 (S)
- BSI approved: No. 8241/8242
- CSA approved: No. CA 101391
- VDE approved: No. 121302 ÜG

### **APPLICATIONS**

- · Exchange equipment
- · Measurement equipment
- FA/OA equipment

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.



### **ORDERING INFORMATION (Solder Contains Lead)**

Part Number	Package	Packing Style	Application Part Number*1
PS7241-1C	8-pin SOP	Magazine case 45 pcs	PS7241-1C
PS7241-1C-F3		Embossed Tape 1 500 pcs/reel	
PS7241-1C-F4			

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

### **ORDERING INFORMATION (Pb-Free)**

Part Number	Package	Packing Style	Application Part Number*1
PS7241-1C-A	8-pin SOP	Magazine case 45 pcs	PS7241-1C
PS7241-1C-F3-A		Embossed Tape 1 500 pcs/reel	
PS7241-1C-F4-A			

<sup>\*1</sup> For the application of the Safety Standard, following part number should be used.

### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	5	V
	Power Dissipation	P□	50	mW/ch
	Peak Forward Current*1	I <sub>FP</sub>	1	Α
MOS FET	Break Down Voltage	VL	400	V
	Continuous Load Current	Iι	120	mA
	Pulse Load Current <sup>*2</sup> (AC/DC Connection)	ILP	200	mA
	Power Dissipation	P□	180	mW/ch
Isolation Vo	Isolation Voltage *3		1 500	Vr.m.s.
Total Power Dissipation		Рт	460	mW
Operating Ambient Temperature		TA	-40 to +85	°C
Storage Temperature		T <sub>stg</sub>	-40 to +100	°C

<sup>\*1</sup> PW = 100  $\mu$ s, Duty Cycle = 1 %

### RECOMMENDED OPERATING CONDITIONS (TA = 25 °C)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	lF	2	10	20	mA
LED Off Voltage	VF	0		0.5	V

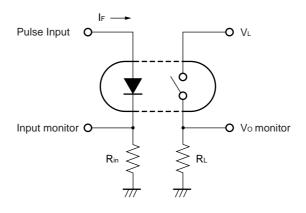
<sup>\*2</sup> PW = 100 ms, 1 shot

<sup>\*3</sup> AC voltage for 1 minute at  $T_A = 25$  °C, RH = 60 % between input and output

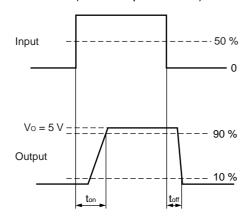
### ELECTRICAL CHARACTERISTICS (TA = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.2	1.4	٧
	Reverse Current	lr	VR = 5 V			5	μΑ
MOS FET	MOS FET Off-state Leakage Current		N.O.: IF = 0 mA, VD = 400 V		0.03	1.0	μΑ
			N.C.: IF = 10 mA, VD = 400 V				
	Output Capacitance	Cout	N.O.: V <sub>D</sub> = 0 V, f = 1.0 MHz		65		pF/ch
			N.C.: V <sub>D</sub> = 0 V, f = 1.0 MHz, I <sub>F</sub> = 10 mA		185		
Coupled	LED On-state Current	<b>I</b> Fon	N.O.: IL = 120 mA			2.0	mA
	LED Off-state Current	<b>I</b> Foff	N.C.: IL = 120 mA				
	On-state Resistance	Ron1	N.O.: IF = 10 mA, IL = 10 mA		21	30	Ω
			N.C.: I <sub>F</sub> = 0 mA, I <sub>L</sub> = 10 mA				
		Ron2	N.O.: I <sub>F</sub> = 10 mA, I <sub>L</sub> = 120 mA, $t \le 10$ ms		16	25	
			N.C.: $I_F = 0 \text{ mA}, I_L = 120 \text{ mA}, t \le 10 \text{ ms}$				
	Turn-on Time *1	ton (N.O.)	If = 10 mA, Vo = 5 V, $R_L = 2 k\Omega$ ,		0.2	1.0	ms
		ton (N.C.)	PW ≥ 10 ms		0.02	0.2	
	Turn-off Time *1	toff (N.O.)			0.02	0.2	
		toff (N.C.)			0.1	1.0	
	Isolation Resistance	Ri-o	Vi-o = 1.0 kVpc	10 <sup>9</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1.0 MHz		0.4		pF/ch

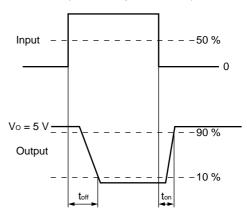
### \*1 Test Circuit for Switching Time



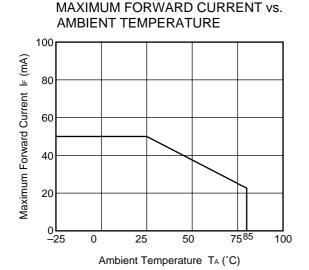
N.O. (between pin 5 and 6)



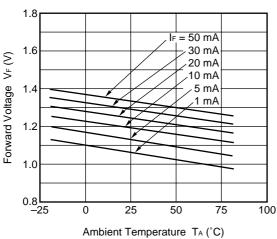
N.C. (between pin 7 and 8)



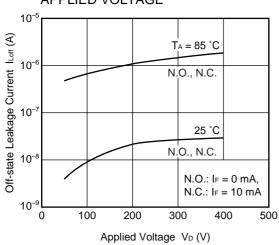
### **★** TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)



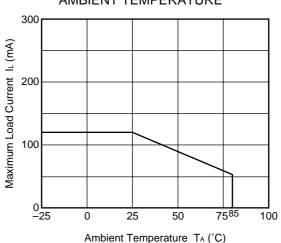




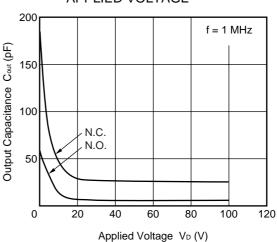
## OFF-STATE LEAKAGE CURRENT vs. APPLIED VOLTAGE



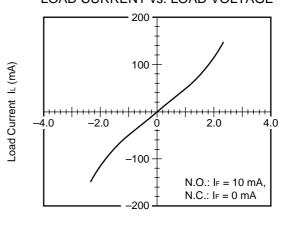
### MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



OUTPUT CAPACITANCE vs. APPLIED VOLTAGE

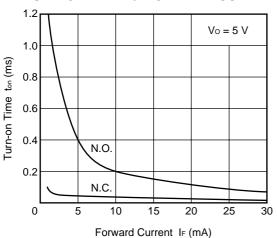


LOAD CURRENT vs. LOAD VOLTAGE

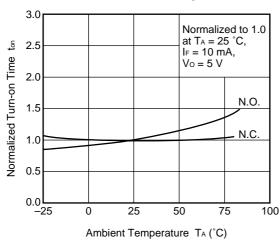


Load Voltage V<sub>L</sub> (V)

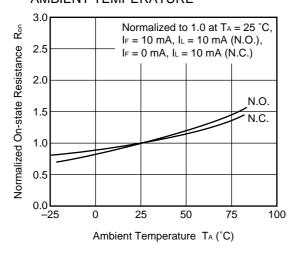
### TURN-ON TIME vs. FORWARD CURRENT



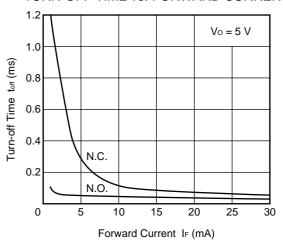
### NORMALIZED TURN-ON TIME vs. AMBIENT TEMPERATURE



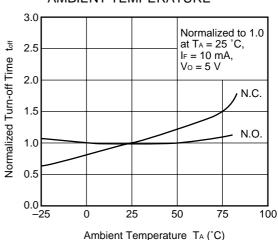
## NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



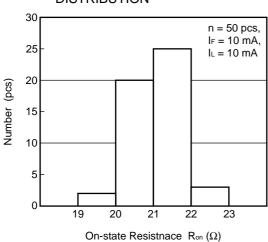
#### TURN-OFF TIME vs. FORWARD CURRENT



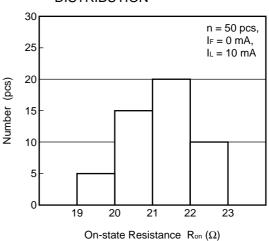
## NORMALIZED TURN-OFF TIME vs. AMBIENT TEMPERATURE



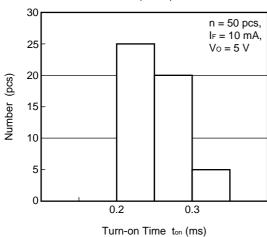




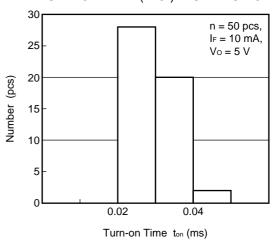
### ON-STATE RESISTANCE (N.C.) DISTRIBUTION



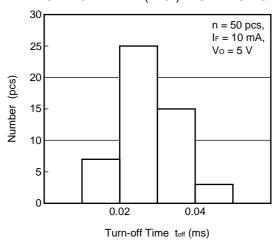
### TURN-ON TIME (N.O.) DISTRIBUTION



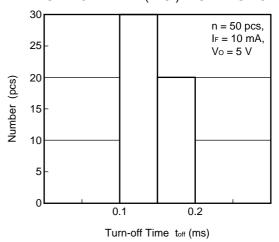
TURN-ON TIME (N.C.) DISTRIBUTION



### TURN-OFF TIME (N.O.) DISTRIBUTION

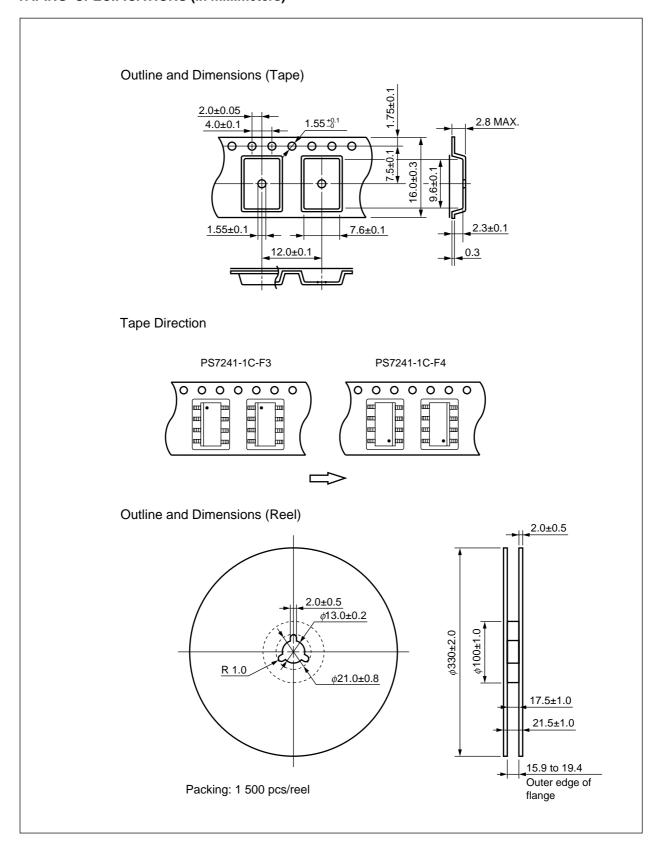


TURN-OFF TIME (N.C.) DISTRIBUTION



**Remark** The graphs indicate nominal characteristics.

### **★ TAPING SPECIFICATIONS (in millimeters)**



### RECOMMENDED SOLDERING CONDITIONS

### (1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

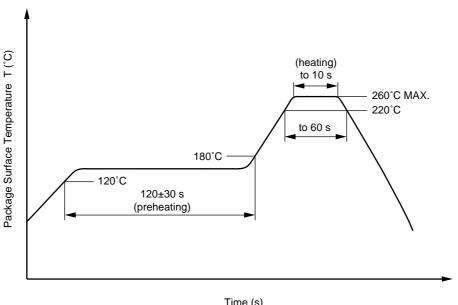
10 seconds or less • Time of peak reflow temperature • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



#### Time (s)

### (2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

### (3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.



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Subject: Compliance with EU Directives

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The -AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (\*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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